

## APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	Manufacturing Method of Fluid Dynamic Pressure Bearing
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Application Type :	regular, utility
Attorney Docket Number :	18.024-AG

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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